



100uF C3 to hold up 3mA supply current for 10mS.

To provide >100uA start up current.

\*. C12, C13, C101-C104 are reworked parts.

PCB Number: PMP10834  
PCB Rev: A

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Orderable: N/A	Designed for: Public Release	Mod. Date: 1/23/2015
TID #: PMP10834	Project Title: 5V/1A ACDC Buck using UCC28C45	
Number: PMP10834	Rev: A	Sheet: 2 of 3
SVN Rev: Version control disabled	Assembly Variant: 001	Size: B
Drawn By:	File: PMP10834RevA_BlankSheet.SchDoc	Contact: http://www.ti.com/support
Engineer: S Yu		



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